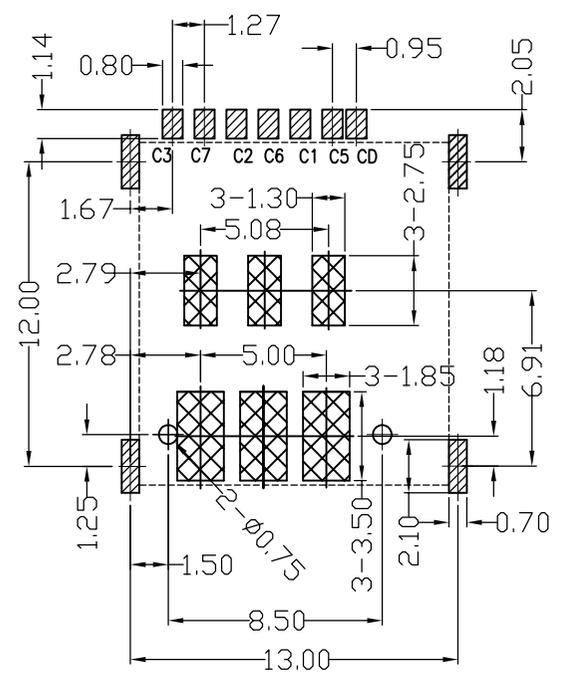
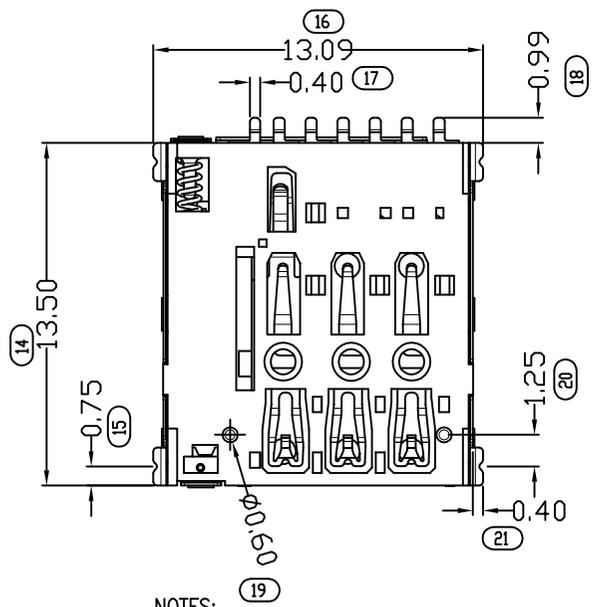
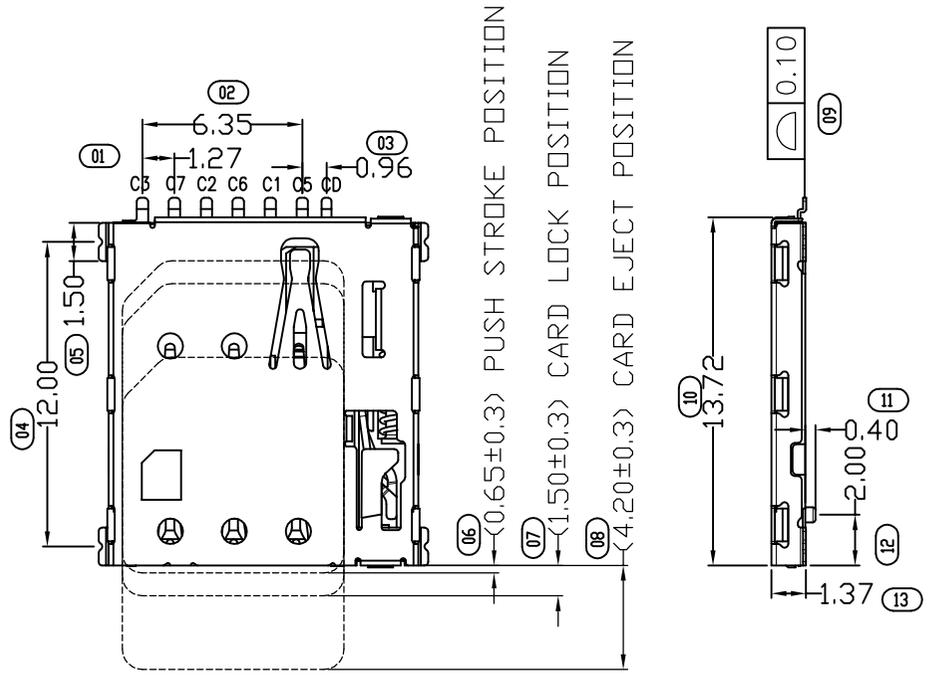


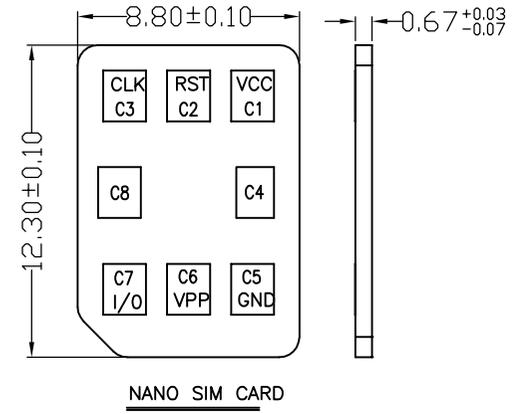
REV	NO	REVISION	DESCRIPTION	DATE	BY
			NEW DWG		
				2016-03-12	



RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE ?05



- NOTES:
- MATERIAL:  
HOUSING:HI-TEMP. PLASIC UL 94V-0  
CONTACT: COPPER ALLOY  
SHELL: STAINLESS STEEL
  - PLATING :  
TERMINAL:  
CONTACT AREA: Au GOLD FLASH.  
SOLDER AREA: AU GOLD FLASH.  
UNDER PLATE: NICKEL.  
SHELL: NICKEL PLATED OVER ALL.  
SOLDER AREA: GOLD FLASH.
  - SPECIALITY:  
3.1 Rated current:1.0A  
3.2 Rated voltage:30V  
3.3 Contact Resistance:100mΩ MAX  
3.4 Insulation Resistance:1000MΩ MIN 500V DC  
3.5 Dielectric withstanding voltage: 500V AC.  
3.6 Solder ability:260+0/-5°C, 30?0s.  
3.7 Durability:5000 Cycles Min.  
3.8 Operating condition:Temperature-40°C~-85°C;  
Humidity 80% R.H MAX



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

		深圳市华德共创科技有限公司 Shenzhen Huade co-create Technology Co.,LTD 电话: 0755-23304126 传真: 0755-29940187						
		-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表		TITLE: 产品名称: NANO 1.37H push 卡座				
X.X	±0.30	X.X*	±3*	APPD: 核准:	PART NO: 产品编号: K-DYX-010			
X.XX	±0.20	X.XX*	±2*	CHECK: 校对: 王建业				
X.XXX	±0.10	X.XXX*	±1*	DRAW: 绘图: 黄艳兰	DATE	SCALE	UNIT	CODE NUMB
				2016-03-12	1:1	mm	A001	

